

## AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application.

### Listing of Claims:

1. (currently amended) A method for electroplating platinum, comprising:

a) providing a substrate; and

b) electrolytically depositing a metal layer on a surface of said substrate, wherein said metal layer comprises platinum and a supplementary constituent, said supplementary constituent comprising particles selected from the group consisting of Cr, Si, Zr, and alloys thereof ~~and has a thickness that is mostly less than about 10 microns,~~

wherein said metal layer is deposited from a single electrolyte composition during a single electrolytic step,

wherein said electrolyte composition comprises a platinum salt and particles of said supplementary constituent having a mean particle diameter ranging between 1 micron and 10 microns and said particles and said electrolyte composition do not include aluminum, and

wherein said particles of said supplementary constituent are deposited in said metal layer from said electrolyte composition.

2. (currently amended) The method of claim 1, wherein said ~~supplementary constituent~~ metal layer further comprises at least one reactive element selected from the group consisting of [[Al, Cr,]] Y, Zr, Hf, La, Sc, Si, ~~Ni, Co, Fe,~~ Ta, and Re.

3. (currently amended) The method of claim 1, wherein said supplementary constituent comprises chromium oxide ~~or chromium~~.

4. (currently amended) The method of claim ~~[[1]]~~3, wherein said ~~supplementary constituent~~ metal layer further comprises at least one reactive element selected from the group consisting of ~~[[Al, Cr,]]~~ Y, ~~[[Zr,]]~~ Hf, La, Sc, ~~Si, Ni, Co, Fe, Ta, and Re.~~

5. (canceled).

6. (canceled).

7. (canceled).

8. (currently amended) The method of claim 1, wherein said substrate comprises an alloy, and the method further comprises:

c) after said step b), aluminizing said metal layer of said substrate; and

d) heating said substrate to form an intermetallic matrix coating from said metal layer, wherein said intermetallic matrix coating comprises platinum, aluminum, said supplementary constituent, and constituents of said alloy substrate.

9. (original) The method of claim 1, wherein said electrolytically deposited metal layer forms a coating on a surface of said substrate, said coating comprising said supplementary constituent, and said substrate comprising an alloy, and the method further comprising:

after said step b), heat treating said coating and said substrate surface to form a metallic solid solution comprising platinum metal, said supplementary constituent, and constituents of said substrate.

10. (currently amended) A method for electroplating platinum on a substrate, comprising:

a) electroplating platinum metal on said substrate via an electrolyte comprising particles of a supplementary constituent and a reactive element, said supplementary constituent having a mean particle diameter ranging between 1 micron and 10 microns, and said particles and said electrolyte not including aluminum; and

b) concurrently with said step a), depositing said particles of said supplementary constituent on said substrate to form a layer comprising platinum and the particles of the supplementary constituent, ~~the layer having a thickness that is mostly less than about 10 microns,~~

wherein said supplementary constituent comprises particles selected from the group consisting of Cr, Si, Zr, and alloys thereof, and at least one reactive element ~~[[is]]~~ selected from the group consisting of ~~[[Al, Cr,]] Y, [[Zr,]] Hf, La, Sc, Si, Ni, Co, Fe, Ta, and Re.~~

11. (original) The method of claim 10, wherein said particles of said supplementary constituent are entrapped within said platinum metal.

12. (original) The method of claim 10, wherein said particles of said supplementary constituent comprise chromium metal powder.

13. (original) The method of claim 10, wherein said electrolyte comprises dinitrodiamine platinum.

14. (original) The method of claim 10, wherein said step a) comprises applying a voltage of from about 1.2 to 2.2 volts between said substrate and an anode.

15. (currently amended) A process for preparing a coated component, comprising:

a) providing a substrate; and

b) electroplating a metal layer on a surface of said substrate from an electrolytic bath comprising a platinum salt electrolyte and particles of at least one supplemental constituent having a mean particle diameter ranging between 1 micron and 10 microns, wherein said electrolytic bath does not including aluminum, said electroplated metal layer ~~has a thickness that is mostly less than about 10 microns and~~ comprises platinum metal and particles of the at least one supplementary constituent and at least one reactive element entrapped within said platinum metal, wherein said at least one supplementary constituent comprises particles selected from the group consisting of Cr, Si, Zr, and alloys thereof and the at least one reactive element is selected from the group consisting of [[Al, Cr,]] Y, [[Zr,]] Hf, La, Sc, ~~Si, Ni, Co, Fe~~, Ta, and Re;

c) depositing aluminum on said electroplated metal layer; and

d) forming a platinum aluminide coating on said substrate, wherein said platinum aluminide coating comprises said at least one supplementary constituent and at least one reactive element.

16. (original) The process of claim 15, wherein said particles and said platinum metal are co-deposited from a single electrolyte composition, and said electrolyte composition comprising said particles.

17. (original) The process of claim 16, further comprising:

c) during said step b), maintaining said particles in suspension.

18. (original) The process of claim 16, wherein said electrolyte composition comprises from about 0.2 to 400 g/L of said particles, and wherein said particles comprise chromium metal powder.

19. (original) The process of claim 15, further comprising:

f) after said step b) and prior to said step c), heating said substrate.

20. (original) The process of claim 19, wherein said step f) comprises heating said substrate to a temperature sufficient to bond said electroplated metal layer to said substrate.

21. (original) The process of claim 20, wherein said temperature sufficient to bond said electroplated metal layer to said substrate is in the range of from about 300 to 650° C.

22. (original) The process of claim 19, wherein said step f) comprises heating said substrate to a temperature sufficient to interdiffuse at least a portion of said electroplated metal layer with said substrate.

23. (original) The process of claim 22, wherein said temperature sufficient to interdiffuse at least a portion of said electroplated metal layer with said substrate is in the range of from about 1000 to 1100° C.

24. (canceled).

25. (canceled).

26. (canceled).

27. (currently amended) A process for preparing a coated component, comprising:

a) providing a substrate;

b) electroplating a platinum metal layer on said substrate, wherein said platinum metal layer is electrodeposited via an electrolyte composition comprising a platinum salt and chromium particles having a mean particle diameter ranging between 1 micron and 10 microns, said particles and said electrolyte composition not including aluminum;

c) concurrently with said step b), depositing said chromium particles on said substrate as part of the platinum metal layer, ~~the layer having a thickness that is mostly less than about 10 microns;~~ wherein said chromium particles are entrapped within said platinum metal layer;

d) optionally, exposing said substrate to a first heat treatment;

e) thereafter, aluminizing said substrate; and

f) exposing said substrate to a second heat treatment to form a platinum aluminide coating on said substrate, wherein said platinum aluminide coating comprises:

chromium within an intermetallic solid solution phase; and

said chromium particles dispersed within said intermetallic solid solution phase.

28. (original) The process of claim 27, wherein said electrolyte composition further comprises dinitrodiamine platinum.

29. (currently amended) The process of claim 27, wherein said electrolyte composition further comprises at least one reactive element selected from the group consisting of [[Al, Cr,] Y, [[Zr,] Hf, La, Sc, Si, ~~Ni~~, ~~Co~~, Fe, Ta, and Re.

30. (original) The process of claim 27, further comprising:

g) during said step b), stirring said electrolyte composition to maintain said chromium particles in suspension.

31 to 48. (canceled).